COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

SEMICONDUCTOR PACKAGING SUBSTRATE AND METHOD OF PRODUCING THE SAME

the	specification of whicl	h							
<u>_x</u>	is attached hereto. was filed on								
	as Application Seri	al No	and was amended on						
I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a). I hereby claim foreign priority benefits under Title 35, Untied States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed: Prior Foreign Application(s):									
	Number	Country	Date Filed(yyyy/mm/dd)	Yes	No				
	90132738	Taiwan, R.O.C.	2001/12/28	Х					
I hereby appoint the following attorney(s) transact all business in the Patent and Trademar Jiawei Huang (Reg. No. 43,330) Maria Erlinda C. Sarno (Reg. No. 37,436) Belinda Lee (Reg. No. 46,863)		oark Office connected therew 0) Charles C.H. Wu 6) Marrina Mei	ute this app vith: (Reg. No (Reg. No	. 39,081)					
	J.C. Patents, Inc. 4 Venture, Suite 250 Irvine, CA 92618 (949) 660-0761		DIRECT TELEPHONE CALLS TO: (Name and telephone number)						
			Jiawei Huang (949) 660-0762						

COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Signature:	Chi-Hsing	Hm	Date:	Jan. 22. 2002
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